

CoolSET™-F1

TDA 16831-4

Off-Line SMPS Controller with
600 V Sense CoolMOS™ on Board



Power Management & Supply



Never stop thinking.

Revision History: 2002-08-08

DS0

Previous Version: 1999-12-10

Page	Subjects (major changes since last revision)
------	--

4	Update of available types.
---	----------------------------

For questions on technology, delivery and prices please contact the Infineon Technologies Offices in Germany or the Infineon Technologies Companies and Representatives worldwide: see our webpage at <http://www.infineon.com>.

CoolMOS™, CoolSET™ are a trademarks of Infineon Technologies AG.

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document.

Please send your proposal (including a reference to this document) to:

mcdocu.comments@infineon.com

**Edition 2002-08-08**

**Published by Infineon Technologies AG,
St.-Martin-Strasse 53,
81669 München, Germany**

**© Infineon Technologies AG 2002.
All Rights Reserved.**

Attention please!

The information herein is given to describe certain components and shall not be considered as warranted characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Infineon Technologies is an approved CECC manufacturer.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office in Germany or our Infineon Technologies Representatives worldwide.

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life-support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

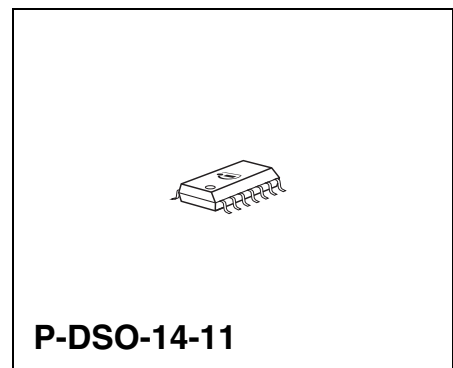
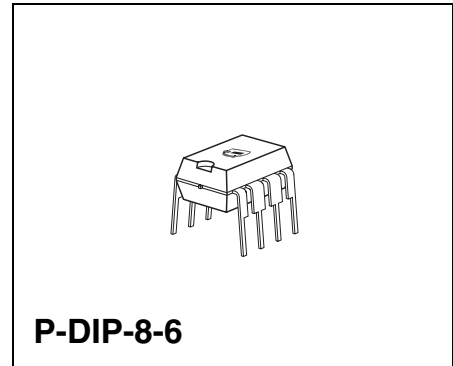
1	Overview	4
1.1	Features	4
1.2	Pin Configurations	6
1.2.1	P-DIP-8-6 for Applications with $P_{OUT} \leq 40$ W: TDA 16831/2/3/4	6
1.2.2	P-DSO-14-11 for Applications with $P_{OUT} \leq 20$ W: TDA 16831G/2G/3G ..	7
1.3	Block Diagram	8
2	Circuit Description	9
3	Electrical Characteristics	13
3.1	Absolute Maximum Ratings	13
3.2	Operating Range	13
3.3	Supply Section	14
3.4	Oscillator Section	14
3.5	PWM Section	15
3.6	Output Section	16
4	Application Circuit	21
5	Package Outlines	22

CoolSET

1 Overview

1.1 Features

- PWM controller + sense CoolMOS attached in one compact package
- 600 V avalanche rugged CoolMOS
- Typical $R_{DSon} = 0.5 \dots 3.5 \Omega$ at $T_j = 25^\circ\text{C}$
- Only 4 active Pins
- Standard DIP-8 Package for Output Power $\leq 40 \text{ W}$
- Only few external components required
- Low start up current
- Current mode control
- Input Undervoltage Lockout
- Max. Duty Cycle limitation
- Thermal Shutdown
- Modulated Gate Drive for low EMI



Type	Ordering Code	Package
TDA 16831	Q67000-A9420	P-DIP-8-6
TDA 16832	Discontinued ¹⁾	P-DIP-8-6
TDA 16833	Q67000-A9389	P-DIP-8-6
TDA 16834	Discontinued ¹⁾	P-DIP-8-6
TDA 16831G	Q67000-A9421	P-DSO-14-11
TDA 16832G	Discontinued ¹⁾	P-DSO-14-11
TDA 16833G	Q67000-A9419	P-DSO-14-11

¹⁾ Last ordering:28.02.2003
Last delivery:31.08.2003

Device	Output Power Range/Required Heatsink ¹⁾	
	$V_{in} = 85-270 \text{ VAC}$	$V_{in} = 190-265 \text{ VAC}$
TDA 16831	10 W / no heatsink	10 W / no heatsink
TDA 16832	20 W / 6 cm ²	20 W / no heatsink
TDA 16833	30 W / 3 cm ²	40 W / no heatsink
TDA 16834	40 W / 3 cm ²	40 W / no heatsink
TDA 16831G	10 W / no heatsink	10 W / no heatsink
TDA 16832G	20 W / 8 cm ²	20 W / no heatsink
TDA 16833G	20 W / no heatsink	40 W / 3 cm ²

¹⁾ $T_A = 70^\circ\text{C}$

1.2 Pin Configurations

1.2.1 P-DIP-8-6 for Applications with $P_{OUT} \leq 40\text{ W}$: TDA 16831/2/3/4

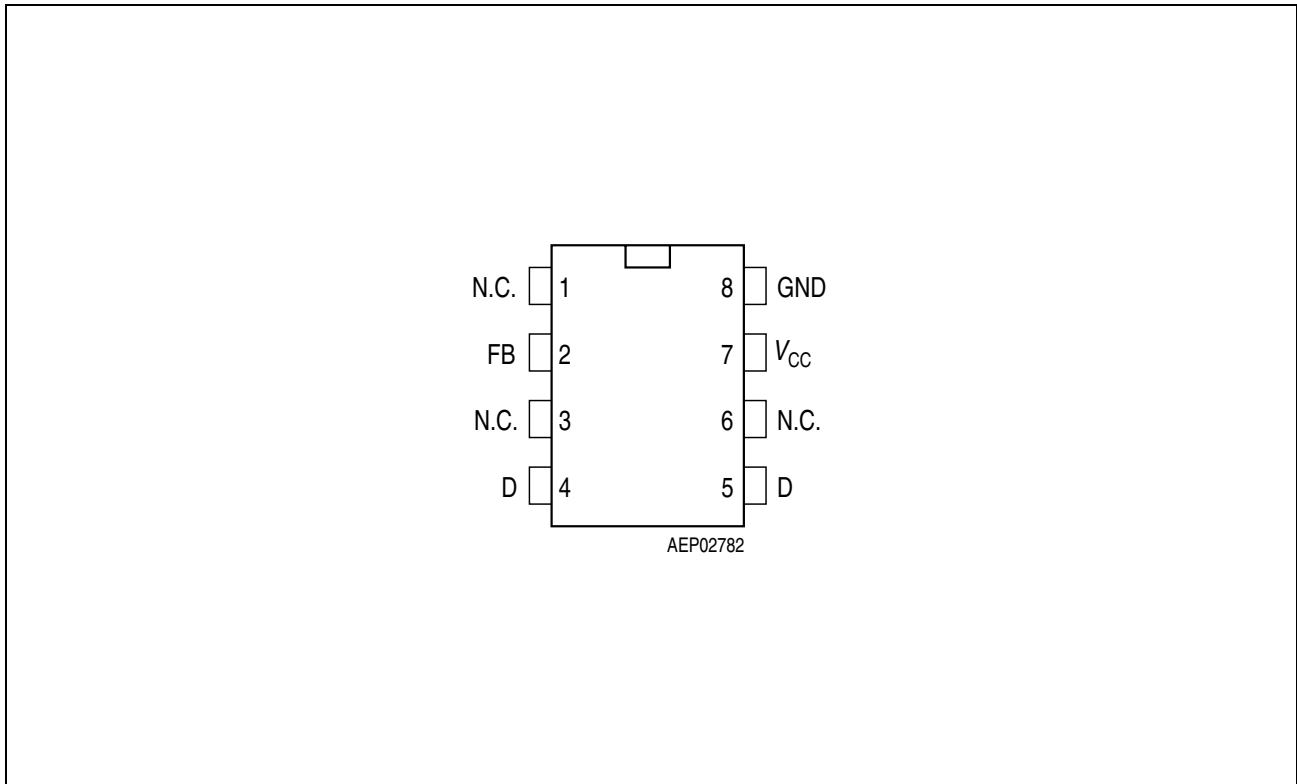


Figure 1 TDA 16831/2/3/4

Pin Definitions and Functions

Pin	Symbol	Function
1	N.C.	Not Connected
2	FB	PWM Feedback Input
3	N.C.	Not Connected
4	D	600 V Drain CoolMOS
5	D	600 V Drain CoolMOS
6	N.C.	Not Connected
7	V_{CC}	PWM Supply Voltage
8	GND	PWM GND and Source of CoolMOS

1.2.2 P-DSO-14-11 for Applications with $P_{OUT} \leq 20\text{ W}$: TDA 16831G/2G/3G

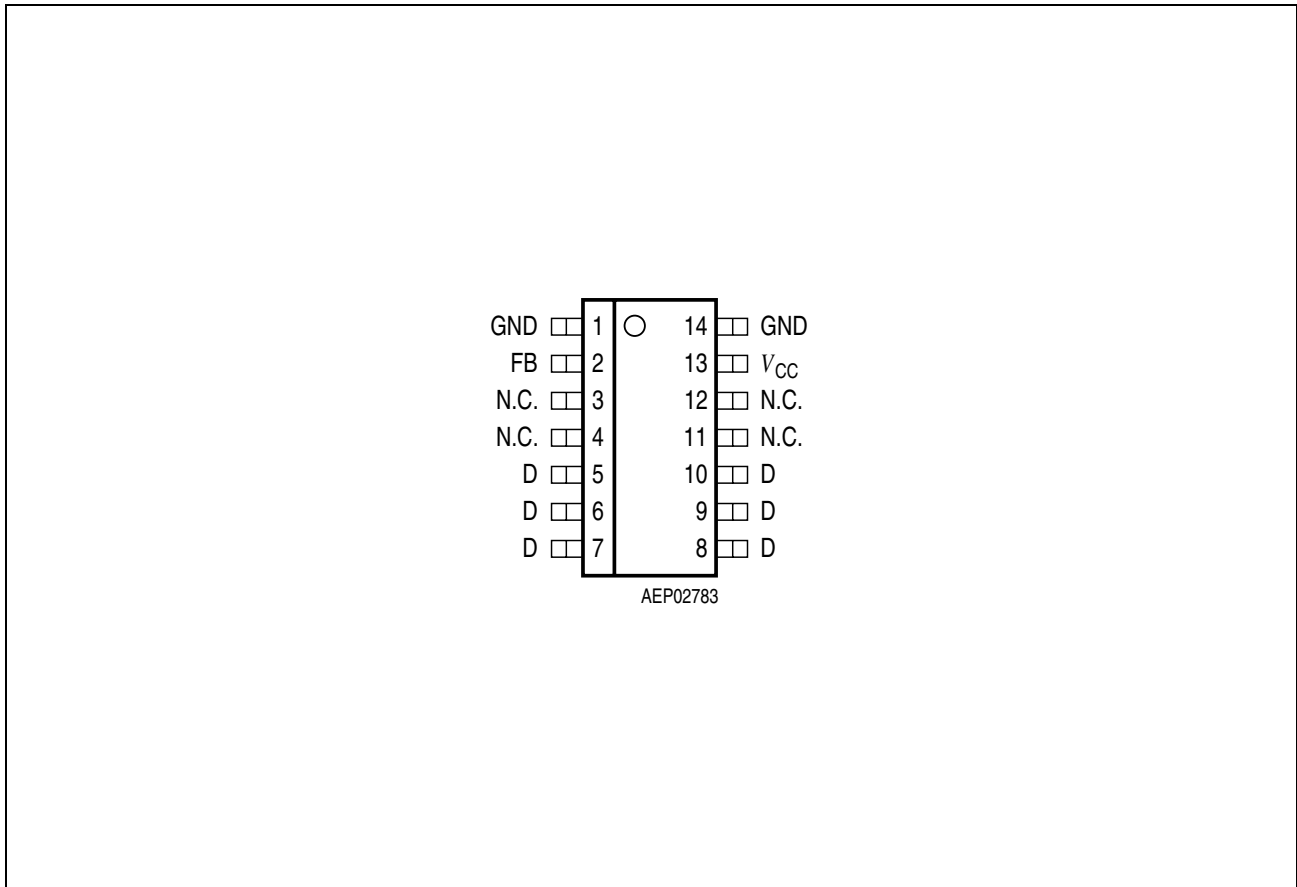


Figure 2 TDA 16831G/2G/3G

Pin Definitions and Functions

Pin	Symbol	Function
1	GND	PWM GND and CoolMOS Source
2	FB	PWM Feedback Input
3	N.C.	Not Connected
4	N.C.	Not Connected
5, 6, 7	D	600 V Drain CoolMOS
8, 9, 10	D	600 V Drain CoolMOS
11	N.C.	Not Connected
12	N.C.	Not Connected
13	V_{CC}	PWM Supply Voltage
14	GND	PWM GND and Source of CoolMOS

1.3 Block Diagram

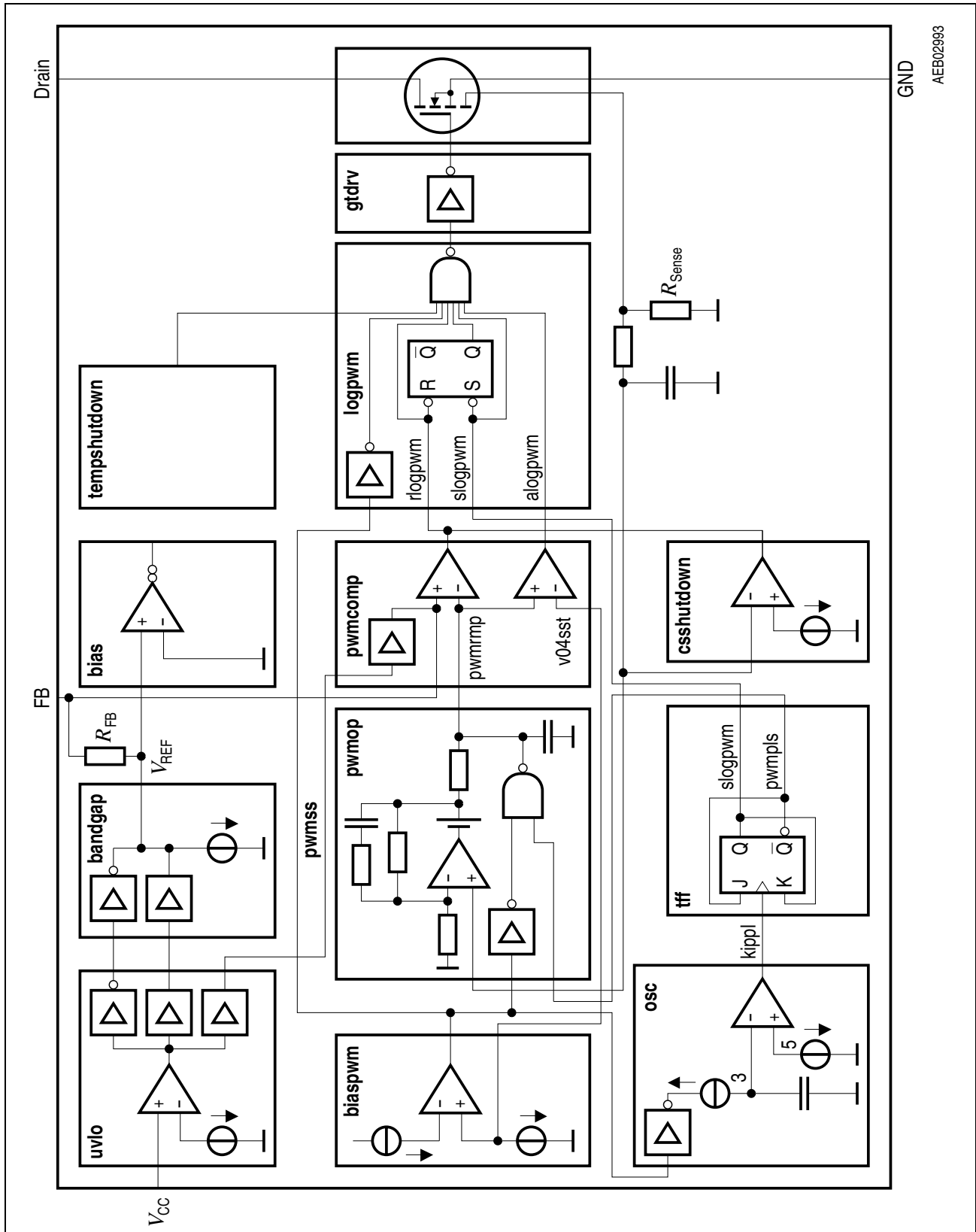


Figure 3 Block Diagram

2 Circuit Description

The TDA 16831-4 is a current mode pulse width modulator with integrated sense CoolMOS transistor. It fulfills the requirements of minimum external control circuitry for a flyback application.

Current mode control means that the current through the MOS transistor is compared with a reference signal derived from the output voltage of the flyback application. The result of that comparison determines the on time of the MOS transistor.

To minimize external circuitry the sense resistor which gives information about MOS current is integrated. The oscillator resistor and capacitor which determine the switching frequency are integrated, too. Special efforts have been made to compensate temperature dependency and to minimize tolerances of this resistor.

The circuit in detail: (see [Figure 3](#))

Start Up Circuit (uvlo)

Uvlo is monitoring the external supply voltage V_{CC} . When V_{CC} is exceeding the on threshold $V_{CCH} = 12\text{ V}$, the bandgap, the bias circuit and the soft start circuit are switched on. When V_{CC} is falling below the off-threshold $V_{CCL} = 9\text{ V}$ the circuit is switched off. During start up the current consumption is about $30\text{ }\mu\text{A}$.

Bandgap (bg)

The bandgap generates an internal very accurate reference voltage of 5.5 V to supply the internal circuits.

Current Source (bias)

The bias circuit provides the internal circuits with constant current.

Oscillator (osc)

The oscillator is generating a frequency twice the switching frequency $f_{\text{switch}} = 100\text{ kHz}$. Resistor, capacitor and current source which determine the frequency are integrated. The charging and discharging current of the implemented oscillator capacitor is internally trimmed, in order to achieve a very accurate switching frequency. Temperature coefficient of switching frequency is very low (see [Page 18](#)).

Divider Flip Flop (tff)

Tff is a flip flop which divides the oscillator frequency by one half to create the switching frequency. The maximum duty cycle is set to $D_{\text{max}} = 0.5$.

Current Sense Amplifier (pwmop)

The positive input of the pwmop is applied to the internal sense resistor. With the internal sense resistor (R_{sense}) the sensed current coming from the CoolMOS is converted into a sense voltage. The sense voltage is amplified with a gain of 32 dB. The amplified sense voltage is connected to the negative input of the pwm comparator. Each time when the CoolMOS transistor is switched on, a current spike is superposed to the true current information. To eliminate this current spike the sense voltage is smoothed via an internal resistor capacitor network with a time constant of $T_{d1} = 100$ ns. This is the first leading edge blanking and only a small spike is left. To reduce this small spike the current sense amplifier is creating a virtual ramp at the output. This is done by a second resistor capacitor network with $T_{d2} = 100$ ns and an op-offset of 0.8 V which is seen at the output of the amplifier. When gate drive is switched off the output capacitor is discharged via pulse signal pwmp1s. The oscillator signal slogpwm sets the RS-flip-flop. The gate drive circuit is switched on, when capacitor voltage exceeds the internal threshold of 0.4 V. This leads to a linear ramp, which is created by the output of the amplifier. Therefore duty cycle of 0% is possible. The amplifier is compensated through an internal compensation network.

The transfer function of the amplifier can be described as

$$\frac{V_o}{V_i} = \frac{K_i}{p \times (1 + T \times p)}; p = j\omega$$

the step response is described with

$$V_o = V_i \times K_i \times \left(t_{\text{on}} - T + T \times e^{-\frac{t_{\text{on}}}{T}} \right)$$

$$K_i = \frac{40}{t_{\text{on}}}$$

$$T = 850 \text{ ns}$$

Comparator (pwmcomp)

The comparator pwmcomp compares the amplified current signal pwmrmp of the CoolMOS with the reference signal pwmin. Pwmin is created by an external optocoupler or external transistor and gives the information of the feedback circuitry. When the pwmrmp exceeds the reference signal pwmin the comparator switches the CoolMOS off.

Circuit Description

Logic (logpwm)

The logic logpwm comprises a RS-flip-flop and a NAND-gate. The NAND-gate insures that CoolMOS transistor is only switched on when sosta is on and pwmin has exceeded minimum threshold and pwmin is below pwrrmp and currentshutdown is off and tempshutdown is off and tff sets the starting impulse. CoolMOS transistor is switched off when pwrrmp exceeds pwmin or duty cycle exceeds 0.5 or pwmc exceeds I_{\max} or silicon temperature exceeds T_{\max} or uvlo is going below threshold. The RS-flip-flop ensures that with every frequency period only one switch on can occur (double pulse suppression).

Gate Drive (gtdrv)

Gtdrv is the driver circuit for the CoolMOS and is optimized to minimize EMI influences and to provide high circuit efficiency. This is done by smoothing the switch on slope when reaching the CoolMOS threshold. Leading switch on spike is minimized then. When CoolMOS is witedhed off, the falling slope of the gate driver is slowed down when reaching 2 V. So an overshoot below ground can't occur. Also gate drive circuit is designed to eliminate cross conduction of the output stage.

Current Shut Down (cssd)

Current shut down circuit switches the CoolMOS immediately off when the sense current is exceeding an internal threshold of 100 mV at R_{sense} .

Tempshutdown (tsd)

Tempshutdown switches the CoolMOS off when junction temperature of the PWM controller is exceeding an internal threshold.

Circuit Description

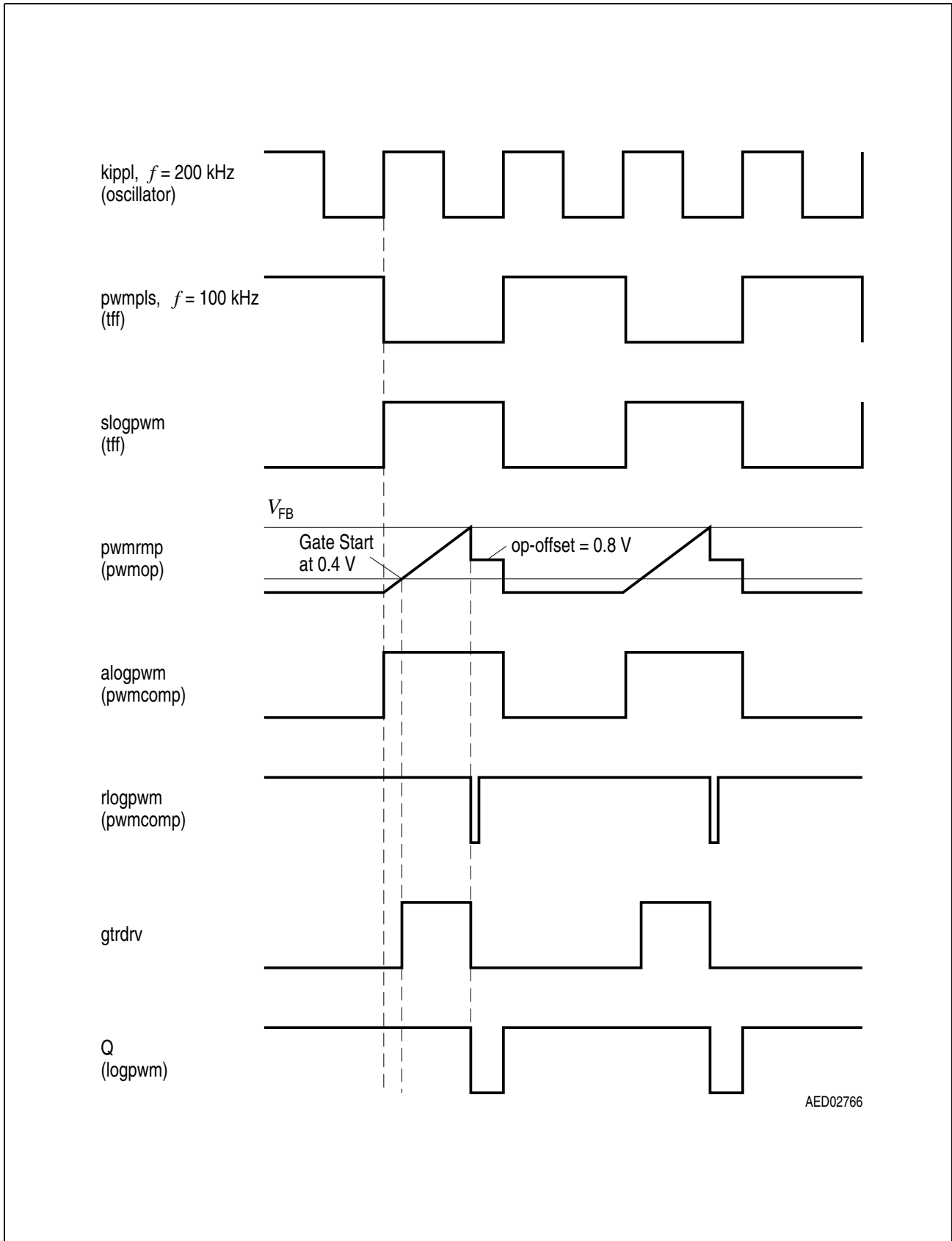


Figure 4 Signal Diagram

3 Electrical Characteristics

3.1 Absolute Maximum Ratings

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
Supply Voltage	V_{CC}	-0.3	V_Z	V	Zener Voltage ¹⁾
Supply + Zener Current	I_{CCZ}	0	20	mA	Page 14 Beware of P_{max} ²⁾
Drain Source Voltage	V_{DS}		600	V	
Avalanche Current	I_{AC}		$I_{csthmax}$	A	$t = 100$ ns
Voltage at FB	V_{FB}	-0.3	5.5	V	
Junction Temperature	T_j	-40	150	°C	
Storage Temperature	T_{stg}	-50	150		
Thermal Resistance System-Air	R_{thSA}		90	K/W	P-DIP-8-6
			125		P-DSO-14-11

¹⁾ Be aware that V_{CC} capacitor is discharged before IC is plugged into the application board.

²⁾ Power dissipation should be observed.

3.2 Operating Range

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
Supply Voltage	V_{CC}	V_{CCH}	V_Z	V	
Junction Temperature	T_j	-25	120	°C	

3.3 Supply Section

 $-25^{\circ}\text{C} < T_j < 120^{\circ}\text{C}, V_{\text{CC}} = 15\text{ V}$

Parameter	Symbol	Limit Values			Unit	Test Conditions
		min.	typ.	max.		
Quiescent Current	I_{CCL}		25	80	μA	
Supply Current Active	I_{CCHA}		4.5	6	mA	TDA 16831/2/G
			6	7.5		TDA 16833/G
			7	8.5		TDA 16834
V_{CC} Turn-On Threshold	V_{CCH}		12	12.5	V	
V_{CC} Turn-Off Threshold	V_{CCL}	8.5	9			
V_{CC} Turn-On/Off Hysteresis	V_{CCHY}		3			
V_{CC} Zener Clamp	V_{Z}	16	17.5	19		
Controller Thermal Shutdown	T_{jSD}	120	135	150	$^{\circ}\text{C}$	TDA 16831/2/3/G/4
Thermal Hysteresis	T_{jHy}		2			

3.4 Oscillator Section

 $-25^{\circ}\text{C} < T_j < 120^{\circ}\text{C}, V_{\text{CC}} = 15\text{ V}$

Parameter	Symbol	Limit Values			Unit	Test Conditions
		min.	typ.	max.		
Accuracy	f	90	100	110	kHz	
Temperature Coefficient	TK f		1000		ppm/ $^{\circ}\text{C}$	

3.5 PWM Section

Parameter	Symbol	Limit Values			Unit	Test Conditions
		min.	typ.	max.		
Duty Cycle	D	0		0.5		
Transimpedance $\Delta V_{FB} / \Delta I_{Drain}^{1)}$	Z_{PWM}		4		V/A	TDA 16831/G
			2			TDA 16832/G
			1.3			TDA 16833/G/4
OP Gain Bandwidth ²⁾	Bw		2		MHz	
OP Phase Margin ²⁾	Φ_{im}		70		Degree	
V_{FB} Operating Range min. Level	V_{FBmin}	0.45		0.85	V	for D = 0 $I_{cs} = 0.95 I_{csth}$
V_{FB} Operating Range max. Level	V_{FBmax}	3.5		4.8		
Feedback Resistance	R_{FB}	3.0	3.7	4.9	K Ω	
Temperature Coefficient R_{FB}	R_{FBTK}		600		ppm/ $^{\circ}C$	
Internal Reference Voltage	V_{refint}	5.3	5.5	5.7	V	
Temperature Coefficient V_{refint}	V_{reftk}		0.2		mV/ $^{\circ}C$	

¹⁾ For discontinuous mode the V_{FB} is described by:

$$V_{FB} = Z_{PWM} \times \frac{I_{PK}}{t_{on}} \times \left(t_{on} - T_1 + T_1 \times e^{-\frac{t_{on}}{T_1}} \right) + 0.6 \times \left(1 - e^{-\frac{t_{on}}{T_2}} \right)$$

$$T_1 = 850 \text{ ns}; T_2 = 200 \text{ ns}$$

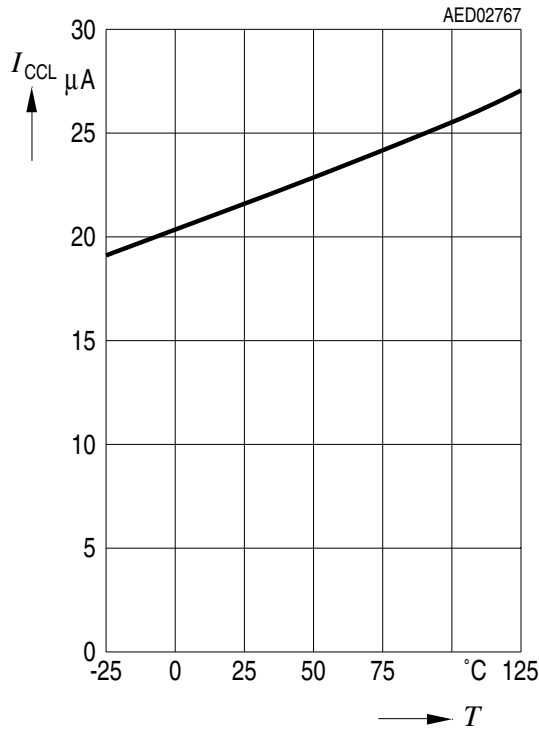
²⁾ Guaranteed by design

3.6 Output Section

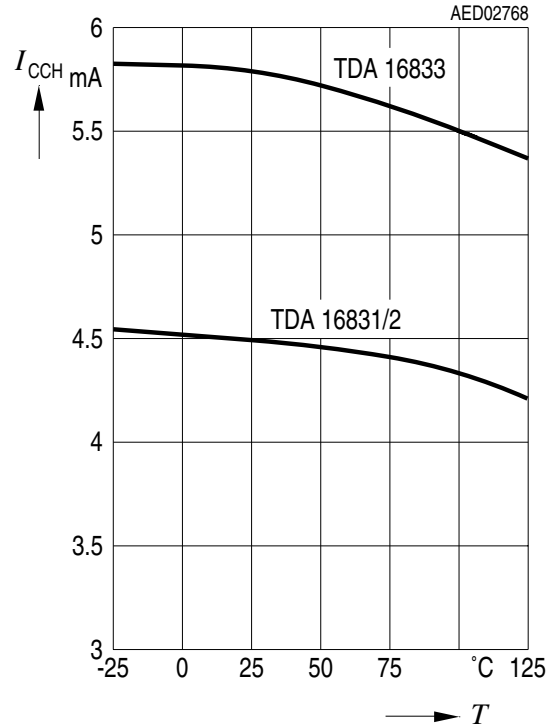
Parameter	Symbol	Limit Values			Unit	Test Conditions
		min.	typ.	max.		
Drain Source Breakdown Voltage $T_A = 25^\circ\text{C}$	$V_{(BR)DSS}$	600			V	
Drain Source On-Resistance $T_A = 25^\circ\text{C}$	R_{DSon}		3.5		Ω	TDA 16831/2/G
			1			TDA 16833/G
			0.5			TDA 16834
Drain Source On-Resistance $-25 < T_A < 120^\circ\text{C}$	R_{DSon}			9	Ω	TDA 16831/2/G
				2.7		TDA 16833/G
				1.6		TDA 16834
Zero Gate Voltage Drain Current	I_{DSS}		0.5	50	μA	$V_{GS} = 0$
Output Capacitance	C_{OSS}		25		pF	TDA16833
Avalanche Current	I_{AR}		$I_{csthmax}$ x		A	$t_{DR} = 100 \text{ ns}$
I_{source} Current Limit Threshold	I_{csth}	0.6	0.9	1.4	A	TDA 16831/G
		1.2	1.8	2.7		TDA 16832/G
		2.2	2.9	4.8		TDA 16833/G
		2.2	2.9	4.8		TDA 16834
Time Constant I_{csth}	t_{csth}		300		ns	
Rise Time	t_{rise}		70			
Fall Time	t_{fall}		50			

Electrical Characteristics

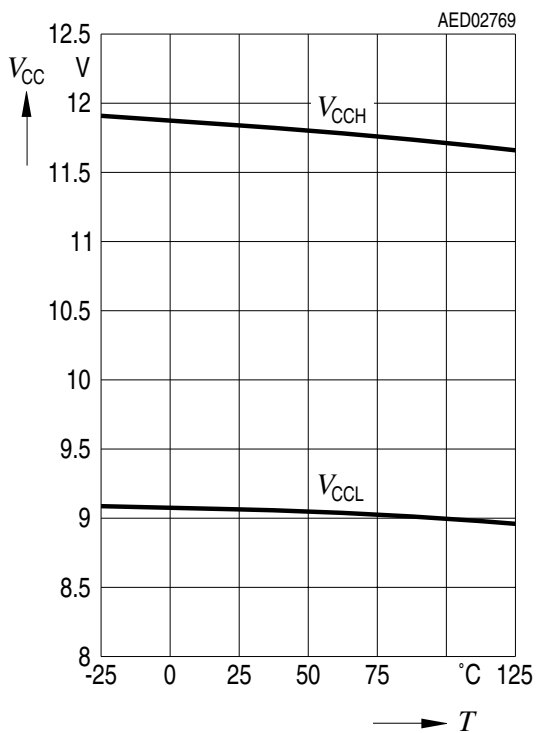
Quiescent Current versus Temperature



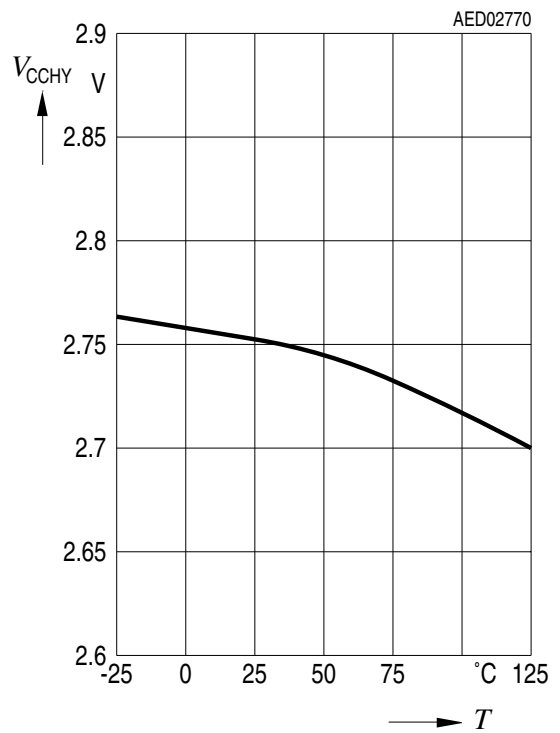
Supply Current Active versus Temperature



Turn On/Off Supply Voltage versus Temperature

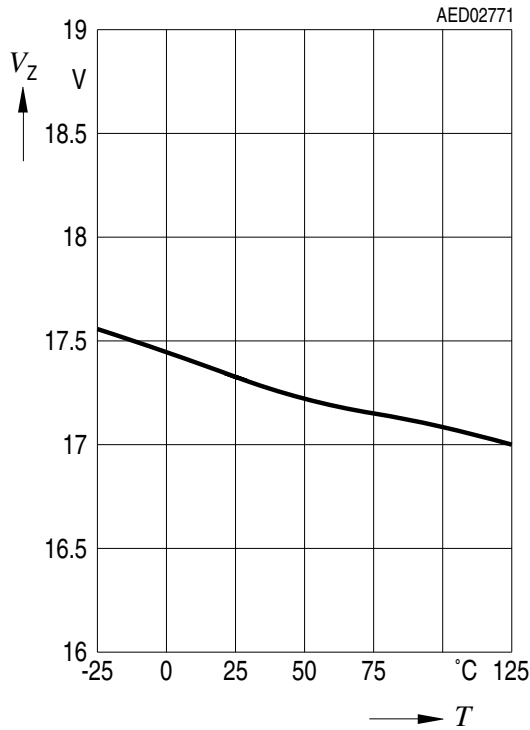


Turn On/Off Hysteresis

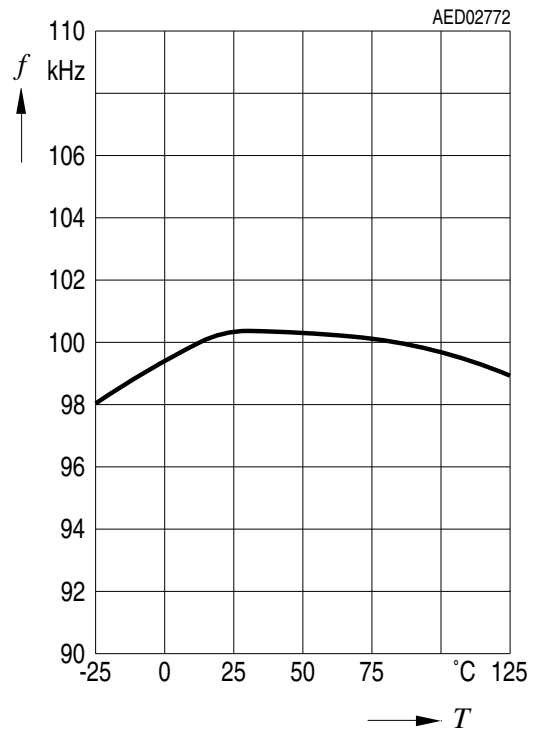


Electrical Characteristics

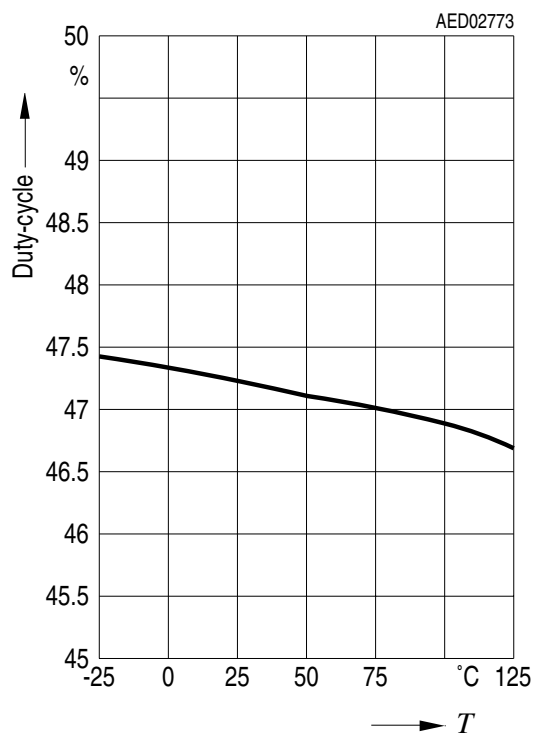
V_{CC} Zener Clamp



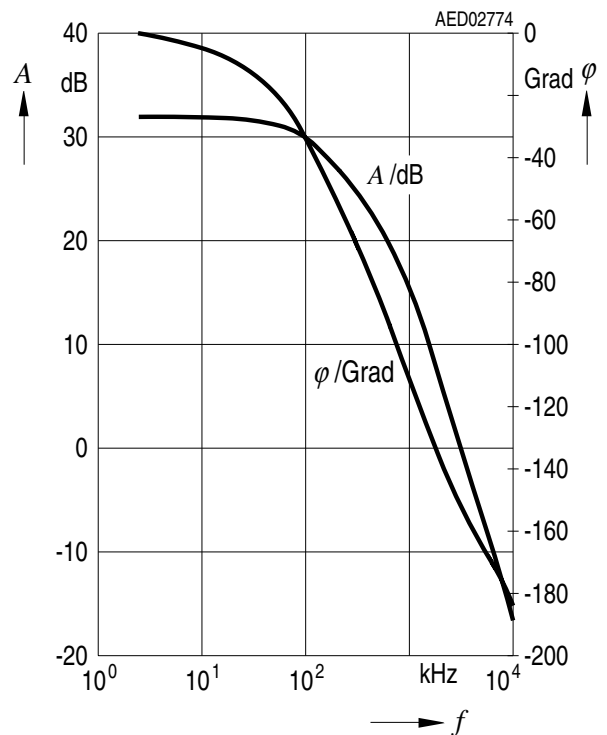
Switching Frequency versus Temperature



Maximum Duty Cycle versus Temperature TDA 16831/2/3/G/4

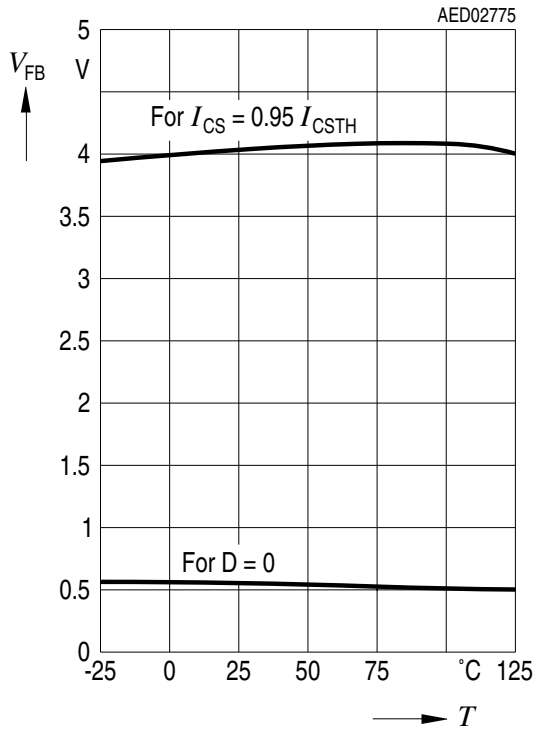


Operational Amplifier Phase and Amplitude versus Frequency

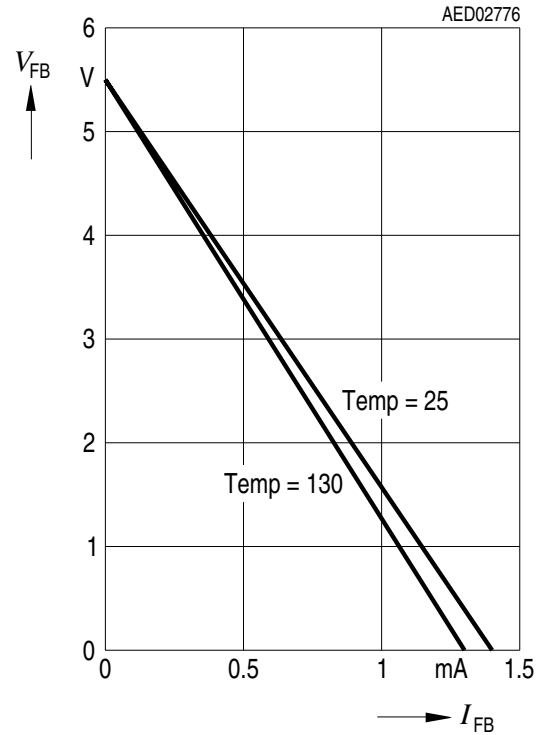


Electrical Characteristics

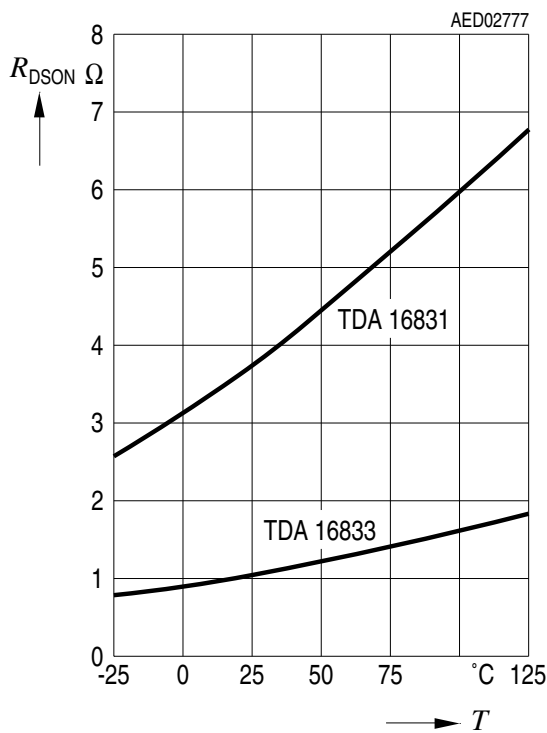
Feedback Voltage Operating Range versus Temperature



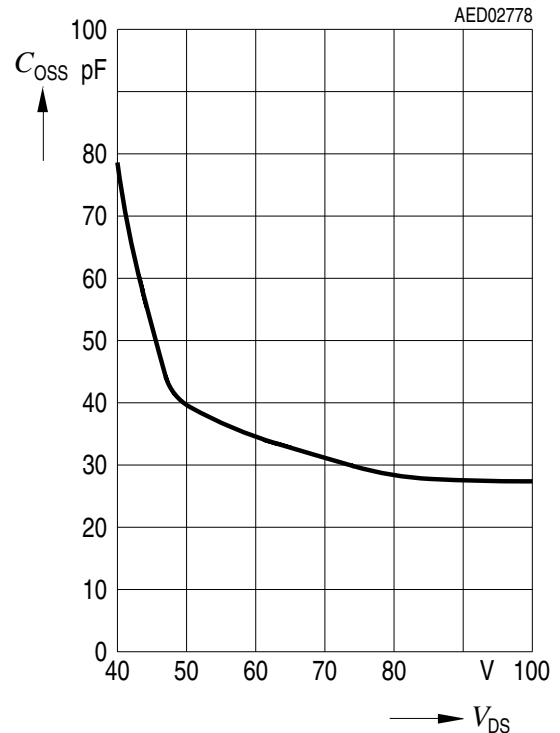
Feedback Voltage versus Feedback Current



R_{DSON} versus Temperature

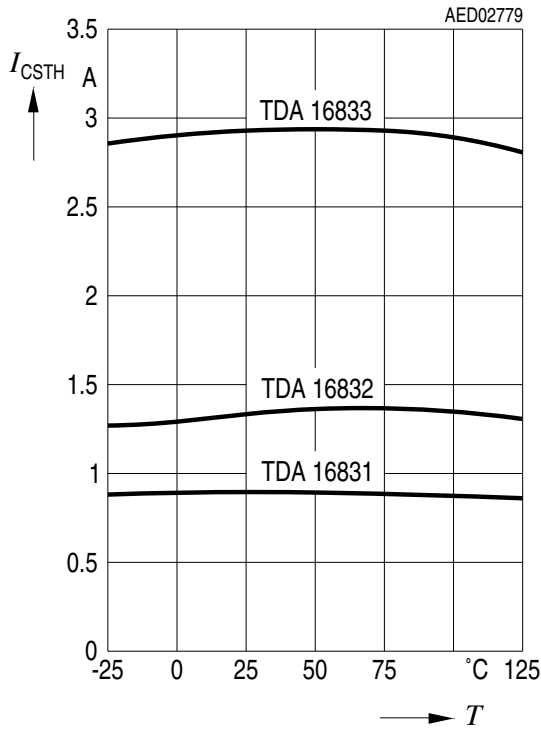


TDA 16833 Output Capacitance C_{OSS} versus V_{DS}

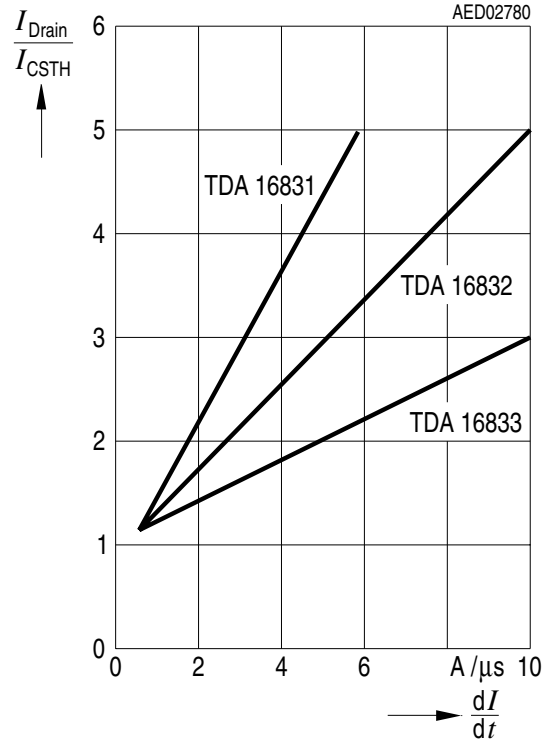


Electrical Characteristics

I_{source} Current Limit Threshold I_{csth} versus Temperature



Normalized Overcurrent Shutdown versus Drain Current Slope



4 Application Circuit

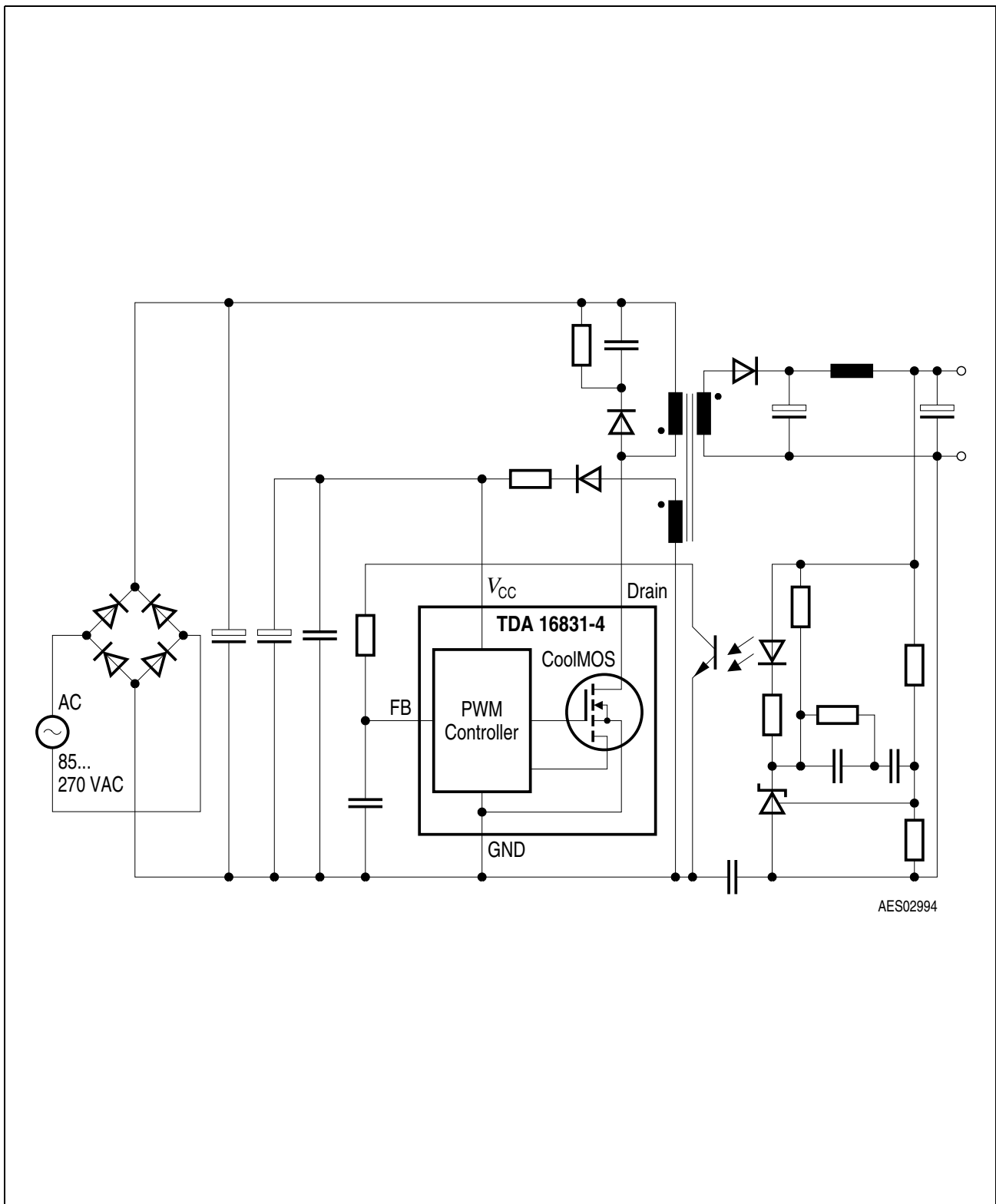
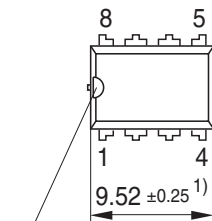
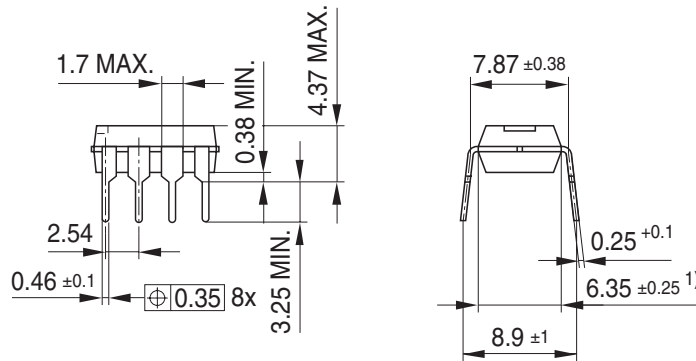


Figure 5 TDA 16832/2G/3G: 4 Active Pins, Version without Soft Start

5 Package Outlines

P-DIP-8-6 (Plastic Dual In-line Package)



Index Marking

¹⁾ Does not include plastic or metal protrusion of 0.25 max. per side

GPD05583

Infineon goes for Business Excellence

“Business excellence means intelligent approaches and clearly defined processes, which are both constantly under review and ultimately lead to good operating results.

Better operating results and business excellence mean less idleness and wastefulness for all of us, more professional success, more accurate information, a better overview and, thereby, less frustration and more satisfaction.”

Dr. Ulrich Schumacher

www.infineon.com

Published by Infineon Technologies AG